



Appln. No.: 09/379,985  
Amendment Dated April 29, 2005  
Reply to Office Action of March 4, 2005

EN995137B

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Appln. No: 09/379,985  
Applicant: Eric Arthur Johnson  
Filed: August 24, 1999  
Title: THERMALLY ENHANCED FLIP CHIP PACKAGE AND METHOD OF FORMING  
TC/A.U.: 2822  
Examiner: Kevin M. Picardat  
Confirmation No.: 2022  
Docket No.: EN9951237B

**RESPONSE**

Mail Stop Reissue  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

Responsive to the Office Action dated March 5, 2005, please reconsider allowance of the above application.

- ☐ **Amendments to the Specification** begin on page                      of this paper.
- ☐ **Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.
- ☐ **Amendments to the Drawings** begin on page                      of this paper and include an attached replacement sheet(s).
- ☐ **Amendments to the Abstract** are on page                      of this paper. A clean version of the Abstract is on page                      of this paper.
- ☒ **Remarks/Arguments** begin on page 2 of this paper.